



**CHENMKO ENTERPRISE CO.,LTD**

**CHT170PT**

**SURFACE MOUNT**

**N-Channel Enhancement Mode Field Effect Transistor**

VOLTAGE 60 Volts CURRENT 0.5 Ampere

*Lead free devices*

**APPLICATION**

- \* Servo motor control.
- \* Power MOSFET gate drivers.
- \* Other switching applications.

**FEATURE**

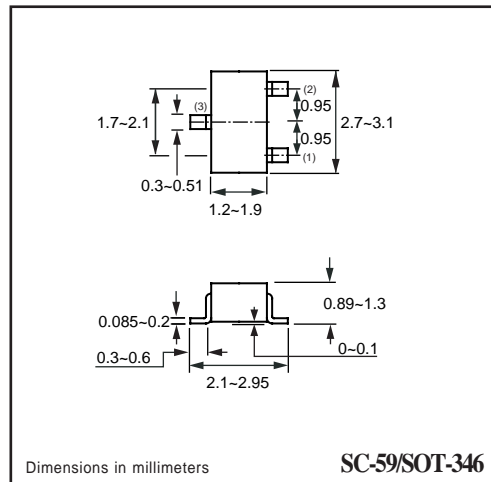
- \* Small surface mounting type. (SC-59)
- \* High density cell design for low R<sub>DS(ON)</sub>.
- \* Suitable for high packing density.
- \* Rugged and reliable.
- \* High saturation current capability.
- \* Voltage controlled small signal switch.

**CONSTRUCTION**

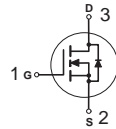
- \* N-Channel Enhancement

**MARKING**

- \* AT



**CIRCUIT**



**Absolute Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	CHT170PT	Units
V <sub>DSS</sub>	Drain-Source Voltage	60	V
V <sub>DGR</sub>	Drain-Gate Voltage	60	V
V <sub>GSS</sub>	Gate-Source Voltage - Continuous	±20	V
	- Non Repetitive (tp < 50µs)	±40	
I <sub>D</sub>	Maximum Drain Current - Continuous	500	mA
	- Pulsed	800	
P <sub>D</sub>	Maximum Power Dissipation	300	mW
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to 150	°C

**Thermal characteristics**

R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	417	K/W
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## RATING CHARACTERISTIC CURVES ( CHT170PT )

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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### OFF CHARACTERISTICS

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 100\ \mu\text{A}$	60	70		V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$			1	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage	$V_{GS} = 15\text{ V}, V_{DS} = 0\text{ V}$			+10	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage	$V_{GS} = 15\text{ V}, V_{DS} = 0\text{ V}$			-10	$\mu\text{A}$

### ON CHARACTERISTICS (Note 1)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\ \mu\text{A}$	0.8	2.1	3.0	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 200\text{ mA}$			5	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 10\ V_{DS(on)}, I_D = 200\text{ mA}$	80			mS

### DYNAMIC CHARACTERISTICS

$C_{iss}$	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$		22	40	pF
$C_{oss}$	Output Capacitance			11	30	
$C_{rss}$	Reverse Transfer Capacitance			2.0	5	
$t_{on}$	Turn-On Time	$V_{DD} = 25\text{ V}$ $I_D = 0.5\text{ A}, V_{GS} = -10\text{ V}, R_{GEN} = 50\ \Omega$			10	nS
$t_{off}$	Turn-Off Time				10	

# RATING CHARACTERISTIC CURVES ( CHT170PT )

## Typical Electrical Characteristics

Figure 1. On-Region Characteristics

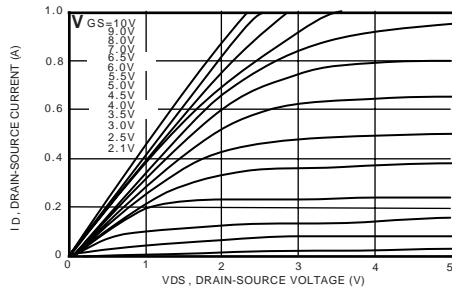


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current

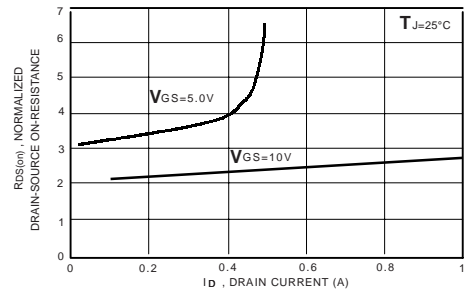


Figure 3. On-Resistance Variation with Temperature

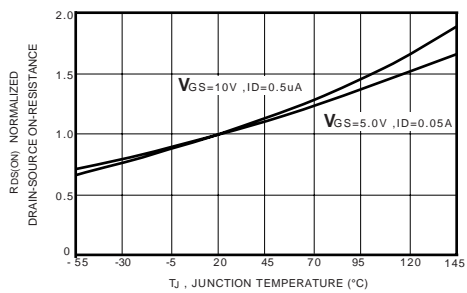


Figure 4. On-Resistance vs , Gate-Source Voltage

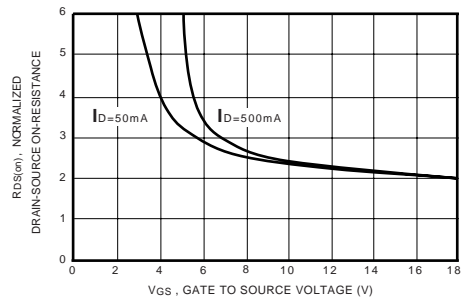


Figure 5. Max Poewr Dissipation vs Ambient Temperature

